

	Type	Hits	Search Text	DBs
1	BRS	954	257/750.ccls.	US-PGPUB; USPAT
2	BRS	1503	257/737.ccls.	US-PGPUB; USPAT
3	BRS	1606	257/773.ccls.	US-PGPUB; USPAT
4	BRS	607	257/760.ccls.	US-PGPUB; USPAT
5	BRS	0	S23 and copper and (UBM or PLM) and insulating and (bump or ball)	US-PGPUB; USPAT
6	BRS	308	copper and (UBM or PLM) and (insulating or dielectric) and (bump or ball)	US-PGPUB; USPAT
7	BRS	132	S27 and first and second and third	US-PGPUB; USPAT
8	BRS	5	S22 and copper and (UBM or PLM) and insulating and (bump or ball)	US-PGPUB; USPAT
9	BRS	21	S21 and copper and (UBM or PLM) and insulating and (bump or ball)	US-PGPUB; USPAT
10	BRS	94	S28 and polyimide	US-PGPUB; USPAT
11	BRS	1	"6417089".PN.	USPAT; USOCR
12	BRS	1	"6184061".PN.	USPAT; USOCR
13	BRS	1	"6107180".PN.	USPAT; USOCR
14	BRS	1	"5470787".PN.	USPAT; USOCR
15	BRS	1	"5137845".PN.	USPAT; USOCR
16	BRS	1	"4646958".PN.	USPAT; USOCR
17	BRS	1	"4622205".PN.	USPAT; USOCR
18	BRS	1	"4516525".PN.	USPAT; USOCR
19	BRS	2572	Chip adj scale adj package	US-PGPUB; USPAT
20	BRS	14	S39 and first and second and third	US-PGPUB; USPAT
21	BRS	37	S38 and copper and (UBM or PLM) and insulating and (bump or ball)	US-PGPUB; USPAT
22	BRS	170	S27 and (oxide or nitride) and (polyimide or BCB)	US-PGPUB; USPAT
23	BRS	1	"20030157438".PN.	US-PGPUB

	Type	Hits	Search Text	DBs
27	BRS	0	(UBM or BLM or PLM) and stack and Cu/Ni/Pd	US-PGPUB; USPAT
28	BRS	0	(UBM or BLM or PLM) and Cu/Ni/Pd	US-PGPUB; USPAT
29	BRS	0	(UBM or BLM or PLM) and copper-nickel-palladium	US-PGPUB; USPAT
30	BRS	323	(UBM or BLM or PLM) and stack	US-PGPUB; USPAT
31	BRS	0	S49 and copper-nickel and palladium	US-PGPUB; USPAT
32	BRS	59	S49 and copper and nickel and palladium	US-PGPUB; USPAT
33	BRS	1	"6426556".PN.	USPAT; USOCR

24	BRS	49	S27 and nickel and palladium	US-PGPUB; USPAT
25	BRS	1	"6249044".PN.	USPAT; USOCR
26	BRS	1	"6426556".PN.	USPAT; USOCR